Si4062DY

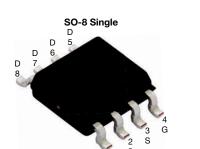
RoHS COMPLIANT

HALOGEN

FREE

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Vishay Siliconix



PRODUCT SUMMARY						
V _{DS} (V)	60					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0042					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 6 V	0.0054					
$R_{DS(on)}$ max. (Ω) at V_GS = 4.5 V	0.0069					
Q _g typ. (nC)	18.8					
I _D (A) ^a	32.1					
Configuration	Single					

Top View

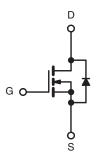
FEATURES

N-Channel 60 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % $\rm R_g$ and UIS tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC primary side switch
- Industrial
- Synchronous rectification
- · Load switch
- DC/DC converters
- DC/AC inverters



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4062DY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS	$(T_A = 25 \ ^\circ C, unless)$	otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	60	V	
Gate-source voltage		V _{GS}	± 20		
	T _C = 25 °C		32.1		
Continuous drain surrent (T 150 °C)	T _C = 70 °C		25.7		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	21.5 ^{b, c}		
	T _A = 70 °C		17 ^{b, c}	•	
Pulsed drain current (t = 100 µs)	I _{DM}	150	— A		
Continuous source-drain diode current	T _C = 25 °C		7		
	T _A = 25 °C	Is Is	3.1 ^{b, c}		
Single pulse avalanche current		I _{AS}	25		
Avalanche energy	L = 0.1 mH	E _{AS}	31.2	mJ	
Maximum power dissipation	T _C = 25 °C		7.8		
	T _C = 70 °C		5		
	T _A = 25 °C	- P _D	3.5 ^{b, c}		
	T _A = 70 °C	1	2.2 ^{b, c}		
Operating junction and storage temperature ra	T _J , T _{stg}	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{b, d}	$t \le 10 s$	R _{thJA}	29	35	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	13	16	- C/W	

Notes

a. Based on $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 80 °C/W

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Si4062DY

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•		•	•		
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	96	-	mV/°C
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA	_	-5.8	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.4	-	2.6	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	30	-	-	Α
		V _{GS} = 10 V, I _D = 20 A	-	0.0035	0.0042	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 6 V, I _D = 15 A	-	0.0043	0.0054	Ω
	_ = = = = = = = = = = = = = = = = = = =	V _{GS} = 4.5 V, I _D = 10 A	-	0.0055	0.0069	
Forward transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 20 A	-	80	-	S
Dynamic ^b	0.0					
Input capacitance	C _{iss}		-	3175	-	pF
Output capacitance	C _{oss}	V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz	_	1265	-	
Reverse transfer capacitance	C _{rss}		-	95	-	
-	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	-	40	60	
Total gate charge		-	18.8	29		
Gate-source charge	Q _{gs}	V _{DS} = 30 V, V _{GS} = 4.5 V, I _D = 10 A	-	8.9	-	nC
Gate-drain charge	Q _{gd}		-	3.8	-	
Output charge	Q _{oss}	V _{DS} = 30 V, V _{GS} = 0 V	-	51.5	80	
Gate resistance	R _g	f = 1 MHz	0.5	2	3	Ω
Turn-on delay time	t _{d(on)}		-	52	100	
Rise time	tr	$V_{DD} = 30 \text{ V}, \text{ R}_1 = 3 \Omega$	-	105	200	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_g = 1 \Omega$	-	26	50	
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	16	30	ns
Rise time	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_{1} = 3 \Omega$	-	6	12	1
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	34	70	
Fall time	t _f		-	8	16	
Drain-Source Body Diode Characteris	tics				<u> </u>	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	7.1	
Pulse diode forward current $(t_p = 100 \ \mu s)$	I _{SM}		-	-	150	А
Body diode voltage	V _{SD}	I _S = 5 A	-	0.74	1.1	V
Body diode reverse recovery time	t _{rr}		-	46	92	ns
Body diode reverse recovery charge	Q _{rr}	I _F = 5 A, di/dt = 100 A/μs,	-	44	88	nC
Reverse recovery fall time	t _a	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	20	-	
Reverse recovery rise time	t _b		-	26	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

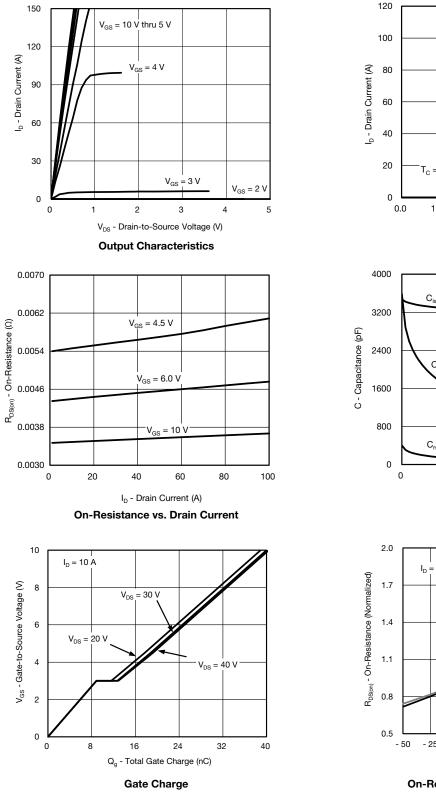
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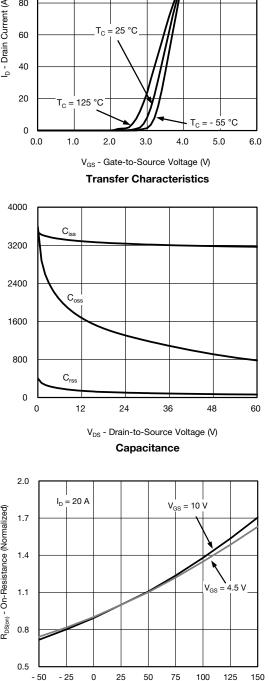
Document Number: 62857



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

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Document Number: 62857

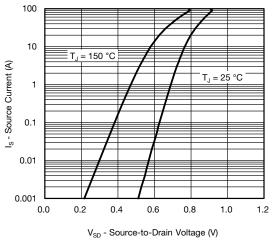
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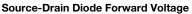


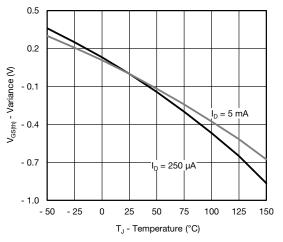
Si4062DY

Vishay Siliconix

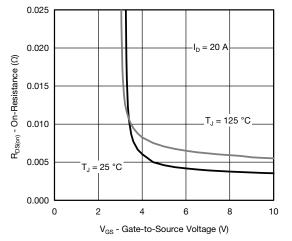
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



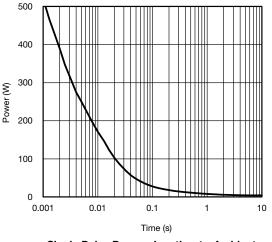




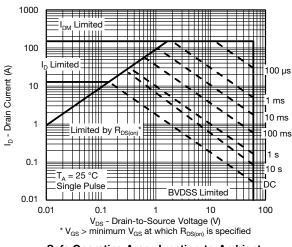
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

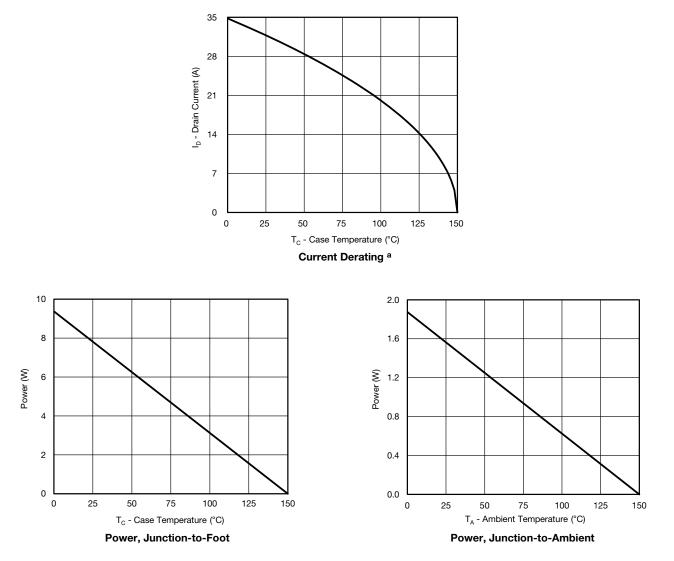
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

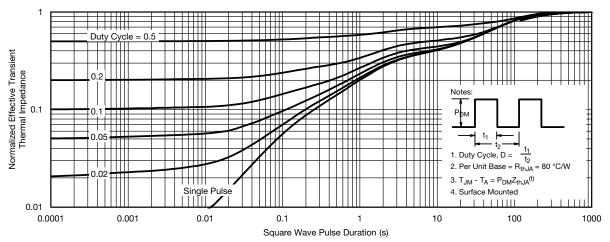
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



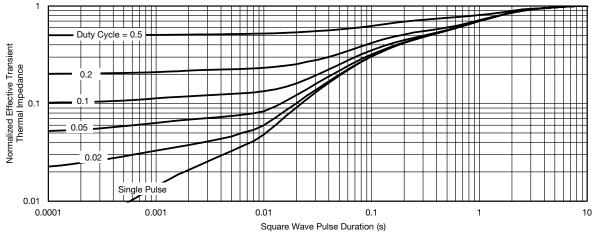
Si4062DY

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62857.

6 Document Number: 62857 513-1383-Rev. A, 17-Jun-13 6 Document Number: 62857 For technical questions, contact: pmostechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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